

# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takamasa YAMASHITA	07/26/2008
Takaya OTSUKI	07/28/2008
Akira HIRAKAWA	07/26/2008
Tatsuya AKASE	07/26/2008
RECEIVING PARTY DATA	
Name:	NIDEC CORPORATION
Street Address:	338 Tonoshiro-cho, Kuze
City:	Minami-ku, Kyoto-shi
State/Country:	JAPAN
Postal Code:	601-8205
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29322063
CORRESPONDENCE DATA	
Fax Number:	(571)313-7421
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	571-313-7440
Email:	mrhodes@kbiplaw.com
Correspondent Name:	Keating & Bennett LLP
Address Line 1:	1800 Alexander Bell Dr.
Address Line 2:	Suite 200
Address Line 4:	Reston, VIRGINIA 20191
ATTORNEY DOCKET NUMBER:	10202.111
NAME OF SUBMITTER:	Michelle Rhodes
Total Attachments: 2	

OP \$40.00 29322063

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**PATENT**  
**REEL: 021306 FRAME: 0661**

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**ASSIGNMENT (WORLDWIDE)**

WHEREAS We, **Takamasa YAMASHITA, Takaya OTSUKI, Akira HIRAKAWA, Tatsuya AKASE** (hereinafter referred to as ASSIGNOR), have invented and own a certain invention entitled **HEATSINK** for which application for Letters Patent of the United States has been

\_\_\_\_\_ executed on even date herewith;  
x filed on 07/29/08 as Serial No. 29/322,063.

WHEREAS, **NIDEC CORPORATION, 338 Tonoshiro-cho, Kuze, Minami-ku, Kyoto 601-8205, JAPAN** (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Dated: 26/07/2008

Takamasa Yamashita  
Takamasa YAMASHITA

Dated: 28/7/2008

Takaya Otsuki  
Takaya OTSUKI

Dated: 26/7/2008

Akira Hirakawa  
Akira HIRAKAWA

Dated: 26/7/2008

Tatsuya Akase.  
Tatsuya AKASE